

CATEGORY	DESCRIPTION	P/N #
CONNECTOR	RJ45 5621 1X1 10P8C 帶壳脚高3.05	MJ5608-BX11-RF1

REV.	ECN NO	DESCRIPTION	REVISED	DATE
A01	—	NEW	WHQ	2021/1/21

MJ5608-BX11-RF1

X	PLATING
0	G/F
1	3U"
2	6U"

NOTES:

ELECTRICAL:

1.VOLTAGE RATING	:125 VAC RMS.
2.CURRENT RATING	:15 AMP.
3.CONTACT RESISTANCE	:30 MILLIOHMS MAX.
4.INSULATION RESISTANCE	:1000 MEGOHMS MIN @ 500V DC .
5.DIELECTRIC STRENGTH	:1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

1.HOUSING MATERIAL	:LEAD FREE POLYESTER UL94V-0.
2.CONTACT MATERIAL	:PHOSPHOR BRONZE $\phi 0.46$ mm ROUND PIN.
3.PLATING	:GOLD PLATING OVER NICKEL.
4.OPERATING	:750 CYCLES MIN.
5.PCB RETENTION PRE-SOLDER	:1 LB MIN.

ENVIRONMENTAL:

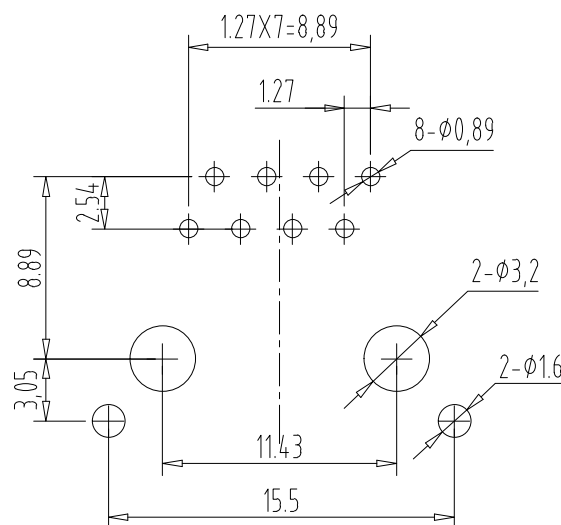
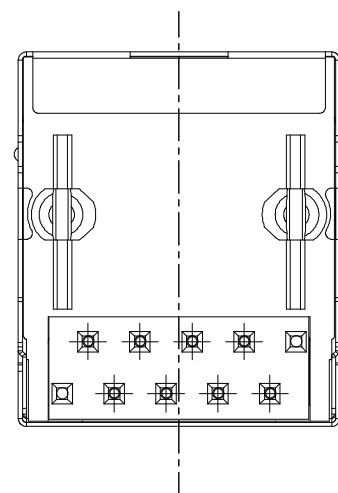
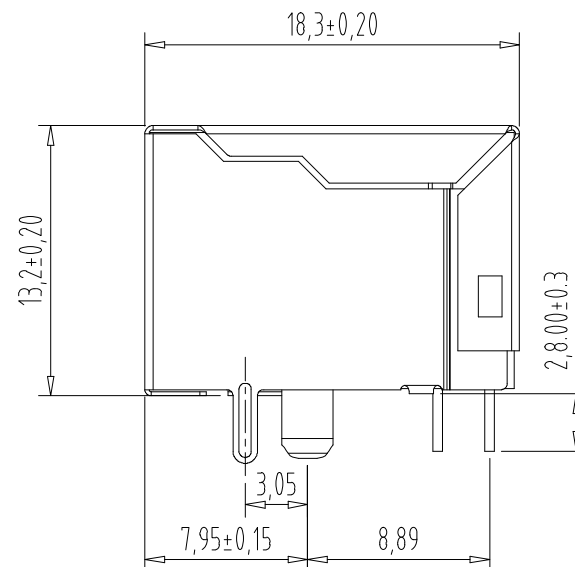
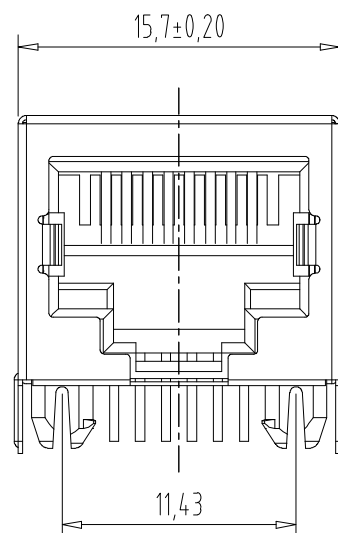
1.Temperature Range	: -40℃~+85℃
2.Relative Humidity	: 90~95% (40±2℃)

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.

PART NUMBER:



UNLESS OTHERWISE SPECIFIED TOLERANCES	SCALE:1/1	UNIT: mm		DWG NO.
	SIZE: A4	PAGE:1 OF 1	REV:A01	HL2021012008
DECIMALS: X :±0.5 X.X :±0.3 X.XX :±0.2	ANGLES: X :±2° X.X :±1°	APPROVED BY	CHECKED BY	PREPARED BY
		DICK	XSX	WHQ
CUSTOMER COPY				



NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR	Remark
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